

### SHARP

OPTO-ANALOG DEVICES DIVISION ELECTRONIC COMPONENTS GROUP **SHARP CORPORATION** 

### **SPECIFICATION**

	1
PHOTOTRIAC MODEL No.	COUPLER
4SF2	1
(Business dealing name:	PC4SF21YWPSF)
	,
Specified for	
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pecification sheets and attached sheets shall be confirmation of the contents, please be sure to approving signature on each.  TOMER'S APPROVAL	pe both side copy.  so send back copies of the Specifications  PRESENTED

Opto-Analog Devices Div. ELECOM Group SHARP CORPORATION



Product name: PHOTOTRIAC COUPLER

Model No.: 4SF21

(Business dealing name: PC4SF21YWPSF)

- These specification sheets include materials protected under copyright of Sharp Corporation ("Sharp").
   Please do not reproduce or cause anyone to reproduce them without Sharp's consent.
- 2. When using this product, please observe the absolute maximum ratings and the instructions for use outlined in these specification sheets, as well as the precautions mentioned below. Sharp assumes no responsibility for any damage resulting from use of the product which does not comply with the absolute maximum ratings and the instructions included in these specification sheets, and the precautions mentioned below.

(Precautions)

- (1) This product is designed for use in the following application areas;
  - · OA equipment Audio visual equipment · He
- · Home appliances
  - · Telecommunication equipment (Terminal)
- · Measuring equipment
- · Tooling machines · Computers

If the use of the product in the above application areas is for equipment listed in paragraphs (2) or (3), please be sure to observe the precautions given in those respective paragraphs.

- (2) Appropriate measures, such as fail-safe design and redundant design considering the safety design of the overall system and equipment, should be taken to ensure reliability and safety when this product is used for equipment which demands high reliability and safety in function and precision, such as;
  - · Transportation control and safety equipment (aircraft, train, automobile etc.)
  - · Traffic signals · Gas leakage sensor breakers · Rescue and security equipment
  - · Other safety equipment
- (3) Please do not use this product for equipment which require extremely high reliability and safety in function and precision, such as;
  - · Space equipment · Telecommunication equipment (for trunk lines)
  - · Nuclear power control equipment · Medical equipment
- (4) Please contact and consult with a Sharp sales representative if there are any questions regarding interpretation of the above three paragraphs.
- 3. Please contact and consult with a Sharp sales representative for any questions about this product.

# PC4SF21YWPSF

1. Application

This specification applies to the outline and characteristics of lead free type phototriac coupler Model No. 4SF21 (Apply line voltage 200V AC).

2. Outline

Refer to the attached sheet, page 6.

3. Ratings and characteristics

Refer to the attached sheet, page 7 to 8.

4. Reliability

Refer to the attached sheet, page 9.

5. Outgoing inspection

Refer to the attached sheet, page 10.

- 6. Supplement
- 6.1 The business dealing name shall be "PC4SF21YWPSF", when this product is ordered or delivered.

And the following selection shall be made as to the critical rate of rise of off-state voltage (dv/dt) in parameter 3.2.  $dv/dt \ge 5kV/\mu s$  [Test conditions]  $V_D=1/\sqrt{2} \cdot V_{DRM}$ ,  $T_0=25^{\circ}C$ 

6.2 Package specification

Refer to the attached sheet, page 11 to 14.

- 6.3 Isolation voltage shall be measured in the following method.
- (1) Short between pins 1 to 3 on the primary side and between pins 4 to 6 on the secondary side.
- (2) The dielectric withstanding tester with zero-cross circuit shall be used.
- (3) The wave form of applied voltage shall be a sine wave.

(It is recommended that the isolation voltage be measured in insulation oil.)

6.4 The relevant models are the models Approved by VDE according to DIN EN 60747-5-2.

Approved Model No.: 4SF21

VDE approved No.: 40008189 (According to the specification DIN EN 60747-5-2)

- Operating isolation voltage U<sub>IORM (Peak)</sub>: 1140V
- Transient voltage : 9000V
- Pollution: 2
- Clearances distance (Between input and output): 8.0 mm (MIN.)
- Creepage distance (Between input and output): 8.0 mm (MIN.)
- Isolation thickness between input and output: 0.40 mm (MIN.)
- Tracking-proof: CTI 175
- · Safety limit values

Current (Isi): 200mA (Diode side)

Power (Psi): 400mW (Phototransistor side)

Temperature (Tsi): 150℃

In order to keep safety electric isolation of photocoupler, please set the protective circuit to keep within safety limit values when the actual application equipment troubled.

Indication of VDE approval "

" is printed on the minimum packing box.



#### Isolation specification according to EN 60747-5-2.

	Parameter	Symbol	Conditions	Rating	Unit	Remark
Class of environmental test		<b></b>	-	40/100/21	-	
Pollution		-	-	2	-	
Maximum oper	ating isolation voltage	U <sub>IORM(PEAK)</sub>	-	1140	V	Refer to
Partial discharg (Between input						the Dia- gram 1, 2
	Diagram 1	Unr	tp=10 s, qc<5pC	1710	V	(Page 5/14)
	Diagram 2	Upr <sub>(PEAK)</sub>	tp=1 s, qc<5pC			
Maximum over	-voltage	U <sub>IOTM(PEAK)</sub>	t <sub>iNi</sub> =60 s	9000	V	
Safety maximu	m ratings				,	
1) Ca	1) Case temperature		I <sub>F</sub> =0, Pc=0	150	$^{\circ}$ C	Refer to
2) Inp	out current	Isi	Pc=0	200	mA	Fig.1, 2
1 '	Electric power     (Output or Total power dissipation)		_	400	mW	(Page 5/14)
Isolation resistance (Test voltage between input and output;			Ta=Tsi	MIN. 10 <sup>9</sup>		
		R <sub>ISO</sub>	Ta=Topr (MAX.)	MIN. 10 <sup>11</sup>	Ω	
	DC 500V)		Ta=25℃	MIN. 10 <sup>12</sup>		

#### Precautions in performing isolation test

- (1) Partial discharge test methods shall be the ones according to the specifications of EN 60747-5-2
- (2) Please don't carry out isolation test (V<sub>iso</sub>) over U<sub>IOTM</sub>. This product deteriorates isolation characteristics by partial discharge due to applying high voltage (ex. U<sub>IOTM</sub>). And there is possibility that partial discharge occurs in operating isolation voltage. (U<sub>IORM</sub>).
- 6.5 This Model is approved by UL, CSA.

Approved Model No.: 4SF21

UL file No. : E64380 CSA file No. : CA95323

CSA approved mark "



" shall be indicated on minimum unit package.

6.6 This product is approved by BSI, SEMKO, DEMKO and FIMKO

Approved Model No.: 4SF21

BSI Certificate No.: 6690/7421 (BS EN60065/BS EN60950)

SEMKO Certificate No.: 501744
DEMKO Certificate No.: 313322
FIMKO Certificate No.: 21600

6.7 This product is not designed against irradiation.

This product incorporates non-coherent light emitting diode.

This product is assembled with electrical input and output.

#### 6.8 ODS materials

- (1) This product shall not contain the following materials.
- ② The following materials shall not be used in the production process for this product.

  Materials for ODS: CFC<sub>S</sub>, Halon, Carbon tetrachloride, 1.1.1-Trichloroethane (Methylchloroform)
- 6.9 Specific brominated flame retardants such as the PBBOs and PBBs are not used in this device at all.

## PC4SF21YWPSF

#### 7. Notes

- 7.1 Circuit design
- (1) The LED used in the Phototriac coupler generally decreases the light emission power by operation. In case of long operation time, please decide I<sub>F</sub> value so that I<sub>F</sub> is more than 2 times of the Maximum value of the Minimum triggering current at circuit design with considering the decreases of the light emission power of the LED. (50% / 5years)
- (2) Input current (I<sub>F</sub>) at off state shall be set 0.1mA or less.
- (3) In case that L (Inductance) load such as motor etc. is used, please use this device after confirming whether this device operates normally in actual condition since there is a case that the zero-cross circuit works and the load does not turn on due to the phase difference of load current.
- (4) If the voltage exceeding the repetitive peak off-state voltage (V<sub>DRM</sub>) in the absolute maximum ratings is applied to the phototriac, it may cause not only faulty operation but breakdown. Make sure that the surge voltage exceeding V<sub>DRM</sub> shall not be applied by using the varistor, CR.

#### 7.2 Usage

Only for triggering medium power triac and high power triac. (This model shall be used under the conditions on which power triac turns on.)

#### 7.3 Cleaning

- (1) Solvent cleaning: Solvent temperature 45°C or less, Immersion for 3 min or less
- (2) Ultrasonic cleaning: The effect to device by ultrasonic cleaning differs by cleaning bath size, ultrasonic power output, cleaning time, PCB size or device mounting condition etc.

Please test it in actual using condition and confirm that any defect doesn't occur

before starting the ultrasonic cleaning.

(3) Applicable solvent: Ethyl alcohol, Methyl alcohol, Isopropyl alcohol

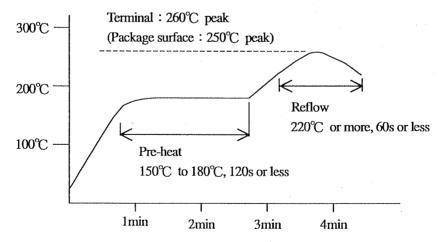
When the other solvent is used, there are cases that the packaging resin is eroded.

Please use the other solvent after thorough confirmation is performed in actual using condition.

- 7.4 Precautions for Soldering Phototriac couplers
- (1) In the case of flow soldering (Whole dipping is possible.)

  It is recommended that flow soldering be carried out at 270°C or less and within 10s (Pre-heating: 100 to 150°C, 30 to 80s): Within 2 time
- (2) If solder reflow:

It is recommended to be done at the temperature and the time within the temperature profile as shown in the figure below. (2 times or less)



(3) In the case of hand soldering

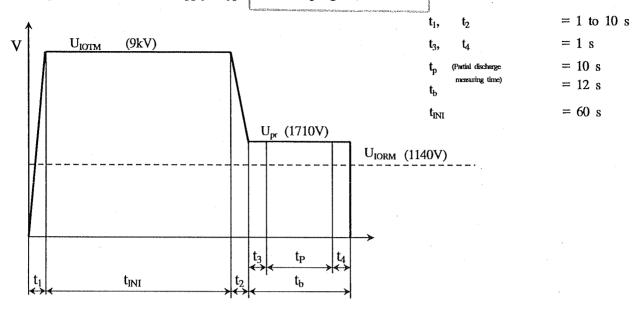
It is recommended that hand soldering be carried out at 400°C or less and within 3s :within 2 times

(4) Other notes

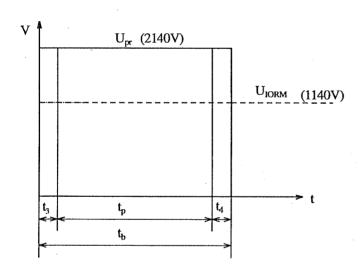
Depending on equipment and soldering conditions (temperature, Using solder etc.), the effect to junction between PCB and lead pins of photocoupler is different.

Please confirm that there is no problem on the actual use conditions.

Method of Diagram 1: Breakdown test (Apply to type lest and sampling test)



Method of Diagram 2: Non breakdown test (Apply to all device test)



=0.1 st3, t4 t p (Partial discharge =1 smeasuring time) =1.2 s

Fig. 1 Safety maximum power dissipation vs. ambient temperature

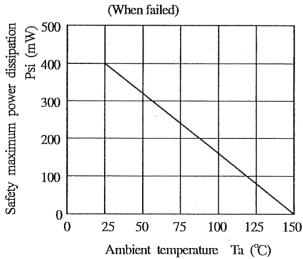
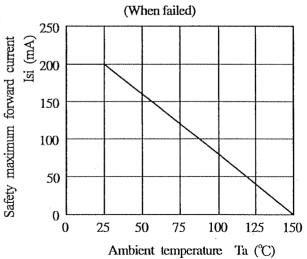
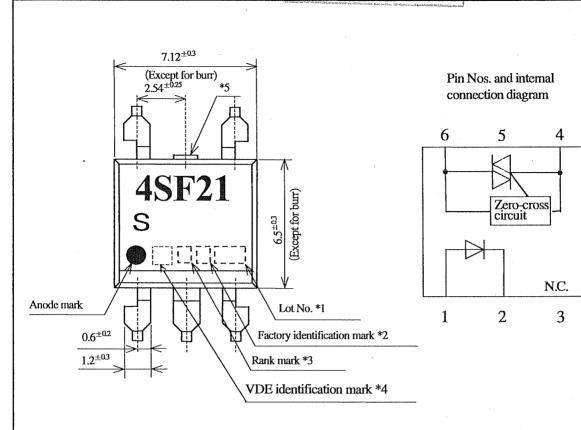
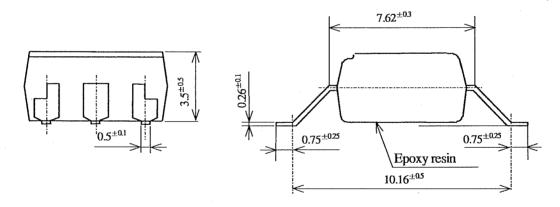


Fig. 2 Safety maximum forward current vs. ambient temperature (When failed)









- \*1) 2-digit number shall be marked according to OLD DIN standard.
- \*2) Factory identification mark applies to the below.

Without: SUN-S Corporation(Japan)

: SUN-S Electronic Technology (KUNSHAN) Co. Ltd (China)

- \*3) Rank mark: "S"
- \*4) VDE identification mark shall be marked "4".
- \*5) Any external connection with Pin 5 is not allowable.

Pin 5 is cut at outside of package.

\*6) Pin material: Copper Alloy

Pin finish: SnCu plating (Cu: TYP. 2%)

Product mass:約0.34g

Name UNIT: 1/1 mm

4SF21 Outline Dimensions
(Business dealing name:PC4SF21YWPSF)



#### 3.1 Absolute maximum ratings

Ta=25°C

	Parameter	Symbol	Rating	Unit	
Input	Forward current *1	$I_{\mathrm{F}}$	50	mA	
прис	Reverse voltage	V <sub>R</sub>	6	V	
Output	RMS on-state current *1	I <sub>T</sub> (rms)	0.1	A	
	Peak one cycle surge current	Isurge	1.2 (50Hz sine wave)	Α	
	Repetitive peak off-state voltage	$V_{DRM}$	800	V	
	Isolation voltage *2	Viso(rms)	5	kV	
Operating temperature Storage temperature		Topr	-30 to +100	$^{\circ}\!\mathbb{C}$	
		Tstg	-55 to +125	$^{\circ}\!\mathbb{C}$	
	Soldering temperature	Tsol	270 (For 10s)	$^{\circ}\!\mathbb{C}$	

<sup>\*1</sup> The derating factors of absolute maximum rating due to ambient temperature are shown in Fig.1, 2.

#### 3.2 Electrical characteristics

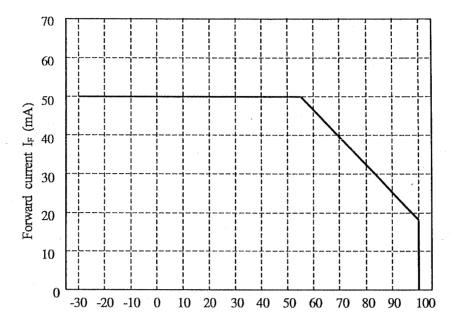
Ta=25°C

Parameter		Symbol MIN		TYP.	MAX.	Unit	Conditions
Input	Forward voltage	$V_{F}$	-	1.2	1.4	· V	I <sub>r</sub> =20mA
прис	Reverse current	$I_R$	-	-	10 <sup>-5</sup>	Α	V <sub>R</sub> =3V
	Repetitive peak off-state current	$I_{DRM}$	-	_	3×10 <sup>-6</sup>	A	V <sub>D</sub> =V <sub>DRM</sub>
	On-state voltage	$V_{\mathrm{T}}$	-	**	2.5	V	I <sub>T</sub> =0.05A
Output	Holding current	I <sub>H</sub>	0.1	_	3.5	mA	V <sub>D</sub> =4V
	Critical rate of rise of off-state voltage	dv/dt	500	1000	_	V/μs	$V_D=1/\sqrt{2} \cdot V_{DRM}$
	Zero-cross voltage	Vox	-	_	20	V	I <sub>F</sub> =15mA, R load
	Minimum trigger current	$I_{FT}$	-		7	mA	$V_D = 4V, R_L = 100 \Omega$
Transfer charac-	Isolation resistance	R <sub>ISO</sub>	$5\times10^{10}$	10 <sup>11</sup>	-	Ω	DC500V 40 to 60%RH
teristics	Turn on time	ton	-	<del>-</del>	50	μs	$V_D$ =4V, $R_L$ =100 $\Omega$ , $I_I$ =20mA

<sup>\*2</sup> AC for 1min, 40 to 60%RH, f=60Hz

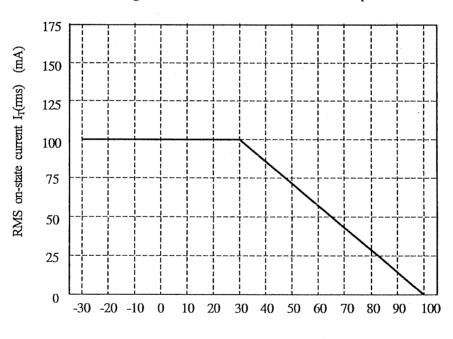


Fig.1 Forward current vs. ambient temperature



Ambient temperature Ta (°C)

Fig.2 RMS on-state current vs. ambient temperature



Ambient temperature Ta (°C)



#### 4. Reliability

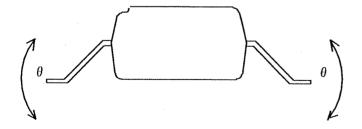
The reliability of products shall satisfy items listed below.

Confidence level: 90%

LTPD: 10 or 20

		****	7.10 OL 20	
Test Items	Test Conditions *1	Failure Judgement	Samples (n)	
		Criteria	Defective(C)	
Solderability *2	245±3℃, 5s	*******	n=11, C=0	
Soldering heat	(Flow soldering) 270°C, 10 s		n=11, C=0	
·	(Soldering by hand) 400°C, 3 s		11-11, 0-0	
Terminal strength (Tension)	Weight: 5.0N 5 s/each terminal		n=11, C=0	
Terminal strength (Bending) *3	Weight: 2.5N 2 times/each terminal	$V_F>U\times 1.2$	n=11, C=0	
Mechanical shock	$15 \text{km/s}^2$ , 0.5ms $3 \text{ times/} \pm \text{X}, \pm \text{Y}, \pm \text{Z} \text{ direction}$	$V_T>U\times 1.2$	n=11, C=0	
Variable frequency vibration	100 to 2000 to 100Hz/4min 200m/s <sup>2</sup>			
Violation	4 times/ X, Y, Z direction	$I_R>U\times 2.0$		
	1 cycle -55°C to +125°C	$I_{DRM}>U\times2.0$		
Temperature cycling	(30min) (30min)		n=22,C=0	
	20 cycles test Without Load	U: Upper specification limit		
High temp. and high humidity storage	+85°C, 85%RH, 500h	L: Lower specification limit	n=22,C=0	
High temp. storage	+125°C, 1000h		n=22,C=0	
Low temp. storage	-55°C, 1000h		n=22,C=0	
Operation life	I <sub>F</sub> =50mA, I <sub>I</sub> =100mA Ta=25°C, 1000h		n=22,C=0	

- \*1 Test method, conforms to EIAJ ED 4701.
- \*2 Solder shall adhere at the area of 95% or more of immersed portion of lead, and pin hole or other holes shall not be concentrated on one portion.
- \*3 Terminal bending direction is shown below.





#### 5. Outgoing inspection

- 5.1 Inspection items
  - (1) Electrical characteristics  $V_{F},\,I_{R},\,I_{DRM},\,V_{T},\,I_{FT},\,R_{ISO},\,Viso$
  - (2) Appearance

#### 5.2 Sampling method and Inspection level

A single sampling plan, normal inspection level II based on ISO 2859 is applied. The AQL according to the inspection items are shown below.

Defect	Inspection item	AQL(%)
Major defect	Electrical characteristics Unreadable marking	0.065
Minor defect	Appearance defect except the above mentioned.	0.25

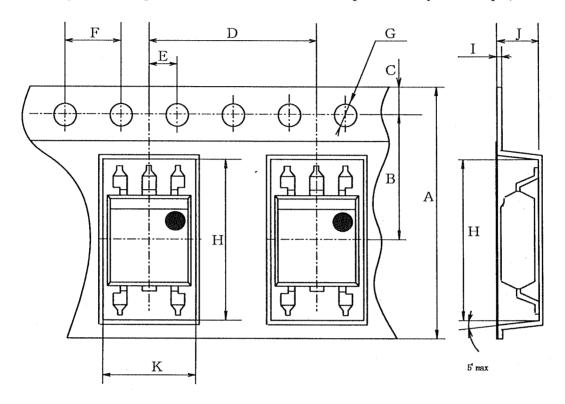


#### 6.2 Package specifications

#### 6.2.1 Taping conditions

(1) Tape structure and Dimensions

The carrier tape has the heat pressed structure of PS material carries tape and three layers cover tape (PET material base).



Dimensions list (Unit: mm)

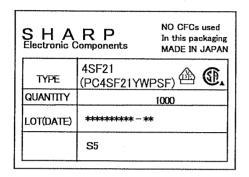
	Α	В	С	D	Е	F	G	Н	I	J	K
1							+0.1				
	$\pm 0.3$	$\pm 0.1$	$\pm 0.10$	±0.1	±0.1	±0.1	-0.0	±0.1	$\pm 0.05$	±0.1	±0.1
	24.0	11.5	1.75	12.0	2.0	4.0	$\phi$ 1.5	12.2	0.40	4.2	7.8

- (2) Reel structure and Dimensions (Refer to the attached sheet, Page 11)
  - The taping reel shall be of plastic (PS material).
- (3) Direction of product insertion (Refer to the attached sheet, Page 11)
- (4) Joint of tape
  - The cover tape and carrier tape in one reel shall be jointless.
- (5) To repair failure-taped devices, cutting a bottom of carrier tape with a cutter.
  - After replacing the cut portion shall be sealed with adhesive tape.
- 6.2.2 Adhesiveness of cover tape
  - The exfoliation force between carrier tape and cover tape shall be 0.2N to 0.7N for the angle 160° to 180°.
- 6.2.3 Rolling method and quantity
  - Wind the tape back on the reel so that the cover tape will be outside the tape.
     Attach more than 20cm of blank tape to the trailer and the leader of the tape and fix the both ends with adhesive tape.
     One reel basically shall contain 1000pcs.
- 6.2.4 Outer packing appearance (Refer to attached sheet, Page 12)



#### 6.2.5 Marking

(1) Label of model No., Lot No. and quantity



· Label dimensions

 $60 \text{mm} \times 42 \text{mm}$ 

· Indications

4SF21

Model No.

TYPE: (PC4SF21YWPSF)

Business dealing name

QUANTITY: 1000

For cartons (1000)

LOT (DATE): \*\*\*\*\*\*\*\*\* Packing lot No.

Mark date code

(2) Bar code label

MODEL NUMBER: PC4SF21YWPSF

: 1000



PRODUCTION DATE CODE: \$5



· Label dimensions

 $65 \text{mm} \times 45 \text{mm}$ 

· Bar coding method

Code 39

· Indications

Model No.: PC4SF21YWPSF Business dealing name

QUANTITY: 1000

For cartons (1000)

Production date code: S5

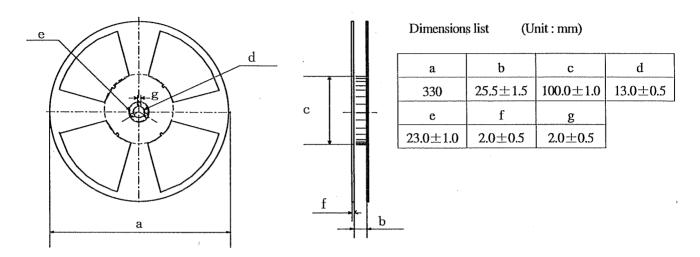
Mark date code

6.2.6 Storage condition

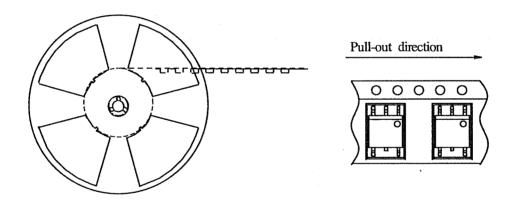
- Taped products shall be stored at the temperature 5 to 30°C and the humidity less than 70%RH. Away from direct sumlight.
- 6.2.7 Safety protection during shipping
  - There shall be no deformation of component or degradation of electrical characteristics due to shipping.



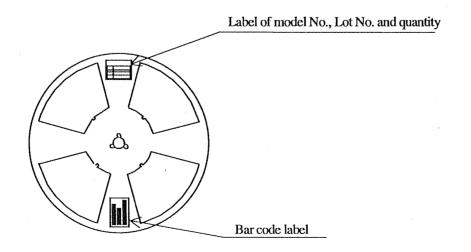
#### Reel structure and Dimensions



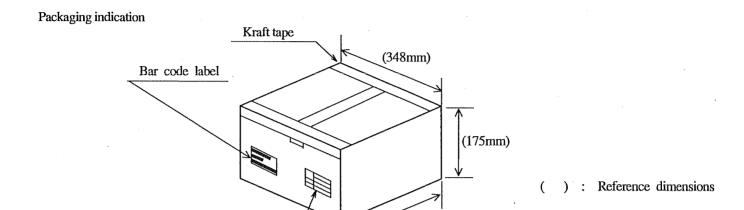
#### Direction of product insertion



Taping reel indication







(348mm)

Label of model No., Lot No. and quantity

#### Outer packing appearance

